



300mA Low-Noise LDO Regulators

Features

- Ultra Low Output Noise—30 μ V (rms)
- Ultra Low 55 μ A No-Load Supply Current
- Ultra Low Dropout 70mV @ 50mA Load
- Guarantee 300mA Output Current
- Over-Temperature and Short-Circuit Protection
- Fixed: 2.70V (G914A), 2.80V (G914B)
3.00V (G914C), 3.30V (G914D)
2.50V (G914E), 2.85V (G914F)
1.50V(G914G), 1.80V(G914H)
- Max. Supply Current in Shutdown Mode < 1 μ A
- Stable with low cost ceramic capacitors

Applications

- Notebook Computers
- Cellular Phones
- PDA
- Hand-Held Devices
- Battery-Powered Application

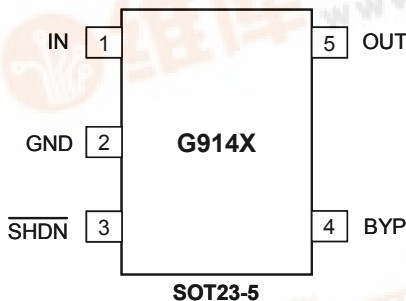
General Description

The G914X is a low supply current, low dropout linear regulator that comes in a space saving SOT23-5 package. The supply current at no-load is 55 μ A. In the shutdown mode, the maximum supply current is less than 1 μ A. Operating voltage range of the G914X is from 2.5V to 5.5V. The over-current protection limit is set at 500mA typical and 400mA minimum. An over-temperature protection circuit is built-in in the G914X to prevent thermal overload. These power saving features make the G914X ideal for use in the battery-powered applications such as notebook computers, cellular phones, and PDA's.

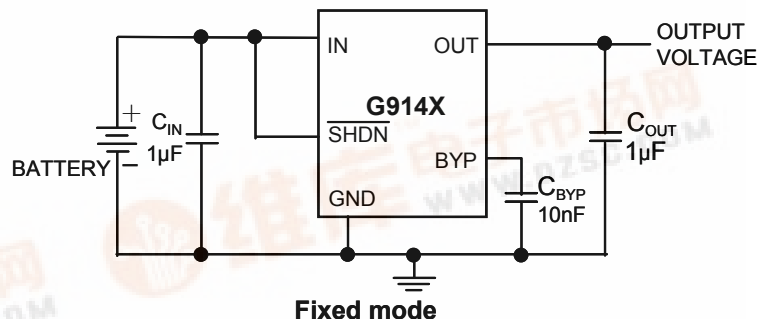
Ordering Information

ORDER NUMBER	MARKING	VOLTAGE	TEMP. RANGE	PACKAGE
G914A	4Axx	2.70V	-40°C~+85°C	SOT 23-5
G914B	4Bxx	2.80V	-40°C~+85°C	SOT 23-5
G914C	4Cxx	3.00V	-40°C~+85°C	SOT 23-5
G914D	4Dxx	3.30V	-40°C~+85°C	SOT 23-5
G914E	4Exx	2.50V	-40°C~+85°C	SOT 23-5
G914F	4Fxx	2.85V	-40°C~+85°C	SOT 23-5
G914G	4Gxx	1.50V	-40°C~+85°C	SOT 23-5
G914H	4Hxx	1.80V	-40°C~+85°C	SOT 23-5

Pin Configuration



Typical Operating Circuit



**Absolute Maximum Ratings**

V_{IN} to GND.....	-0.3V to +7V
Output Short-Circuit Duration.....	Infinite
All Other Pins to GND.....	-0.3V to ($V_{IN} + 0.3V$)
Continuous Power Dissipation ($T_A = +25^\circ\text{C}$)	
SOT 23-5	520 mW

Operating Temperature Range.....	-40°C to +85°C
Junction Temperature.....	+150°C
$\theta_{JA}^{(1)}$	240°C/Watt
Storage Temperature Range.....	-65°C to +160°C
Lead Temperature (soldering, 10sec).....	+260°C

Note ⁽¹⁾: See Recommended Minimum Footprint (Figure 2)

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

($V_{IN}=V_{OUT(STD)}+1V$, $V_{SHDN}=V_{IN}$, $T_A=T_J=25^\circ\text{C}$, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
Input Voltage (Note 2)	V_{IN}			Note2	-	5.5	V	
Output Voltage Accuracy	V_{OUT}	Variation from specified V_{OUT} , $I_{OUT}=1\text{mA}$, $V_{OUT}\geq 2.5V$ version		-2	-	2	%	
		For G914H, $I_{OUT}=1\text{mA}$		-3	-	3		
		For G914G, $I_{OUT}=1\text{mA}$		-4	-	4		
Maximum Output Current					300	-	mA	
Current Limit (Note 3)	I_{LIM}				500	-	mA	
Ground Pin Current	I_Q	$V_{IN}=3.6V$	$I_{LOAD}=0\text{mA}$		55	120	μA	
			$I_{LOAD}=50\text{mA}$		145			
			$I_{LOAD}=300\text{mA}$		265			
Dropout Voltage (Note 4)	V_{DROP}	$I_{OUT}=1\text{mA}$	$I_{OUT}=50\text{mA}$, $V_{OUT}\geq 2.7V$ Version		2		mV	
			$I_{OUT}=150\text{mA}$	$V_{O(NOM)}\geq 3.0V$		70		
				$2.5V\leq V_{O(NOM)}\leq 2.85V$		230		
				$V_{O(NOM)}=1.8V$		250		
			$I_{OUT}=300\text{mA}$	$V_{O(NOM)}=1.5V$		380		
				$V_{O(NOM)}\geq 3.0V$		510		
				$2.5V\leq V_{O(NOM)}\leq 2.85V$		450		600
$V_{O(NOM)}=1.8V$		500	660					
$V_{O(NOM)}=1.5V$		760	960					
$V_{O(NOM)}=1.5V$		910	1220					
Line Regulation	ΔV_{LNR}	$V_{IN}=V_{OUT}+100\text{mV}$ to 5.5V, $I_{OUT}=1\text{mA}$			0.1	0.28	%/V	
Load Regulation (Note 5)	ΔV_{LDR}	$I_{OUT}=1\text{mA}$ to 150mA			0.35		%	
		$I_{OUT}=1\text{mA}$ to 300mA				2		
Power Supply Rejection Ratio	PSRR	$I_{OUT}=30\text{mA}$, $C_{BYP}=10\text{nF}$, $f=120\text{HZ}$			57		dB	
Output Voltage Temperature Coefficient	$\Delta V_O/\Delta T$	$I_{OUT}=50\text{mA}$, $T_J=25^\circ\text{C}$ to 125°C			30		ppm/°C	
Output Voltage Noise (10Hz to 100kHz) (G914H)	e_n	$V_{IN}=V_{OUT}+1V$	$C_{OUT}=1\mu\text{F}$, $I_{OUT}=150\text{mA}$, $C_{BYP}=1\text{nF}$		52		μV_{RMS}	
			$C_{OUT}=1\mu\text{F}$, $I_{OUT}=150\text{mA}$, $C_{BYP}=10\text{nF}$		35			
			$C_{OUT}=1\mu\text{F}$, $I_{OUT}=150\text{mA}$, $C_{BYP}=100\text{nF}$		30			
			$C_{OUT}=1\mu\text{F}$, $I_{OUT}=1\text{mA}$, $C_{BYP}=10\text{nF}$		26			
SHUTDOWN								
SHDN Input Threshold	V_{IH}	Regulator enabled		$V_{IN}-0.7$			V	
	V_{IL}	Regulator shutdown				0.4		
SHDN Input Bias Current	I_{SHDN}	$V_{SHDN}=V_{IN}$	$T_A=+25^\circ\text{C}$		0.003	0.1	μA	
Shutdown Supply Current	I_{QSHDN}	$V_{OUT}=0V$	$T_A=+25^\circ\text{C}$			1		
THERMAL PROTECTION								
Thermal Shutdown Temperature	T_{SHDN}				150		°C	
Thermal Shutdown Hysteresis	ΔT_{SHDN}				15		°C	

Note 1: Limits is 100% production tested at $T_A=+25^\circ\text{C}$. Low duty pulse techniques are used during test to maintain junction temperature as close to ambient as possible.

Note 2: $V_{IN(min)}=V_{OUT(STD)}+V_{DROPOUT}$

Note 3: Not tested. For design purposes, the current limit should be considered 400mA minimum to 600mA maximum.

Note 4: The dropout voltage is defined as ($V_{IN} - V_{OUT}$) when V_{OUT} is 100mV below the value of V_{OUT} for $V_{IN} = V_{OUT} + 1V$. The performance of every G914X version, see "Typical Performance Characteristics".

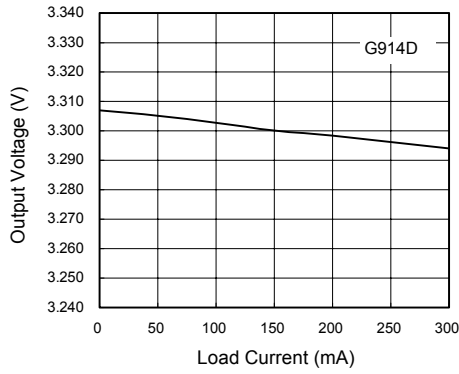
Note 5: Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 1mA to 300mA. Changes in output due to heating effects are covered by the thermal regulation specification.



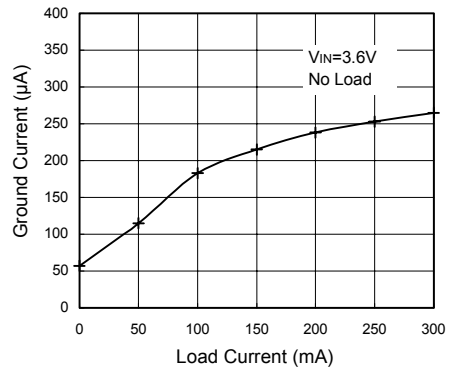
Typical Performance Characteristics

($V_{IN} = V_{O} + 1V$, $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $V_{SHDN} = V_{IN}$, G914D, $T_A = 25^\circ C$, unless otherwise noted.)

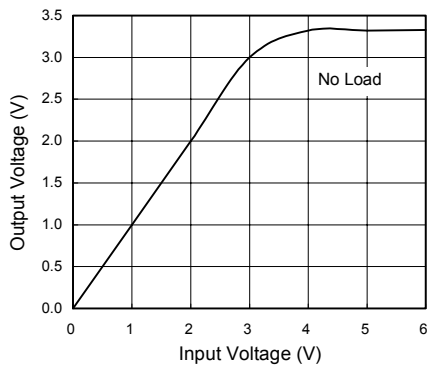
Output Voltage vs. Load Current



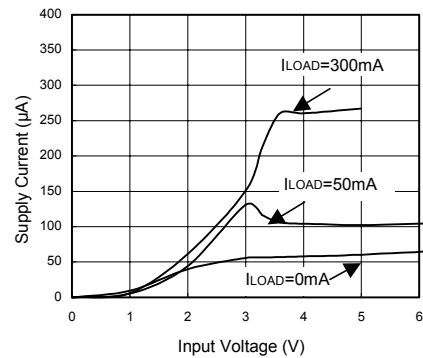
Ground Current vs. Load Current



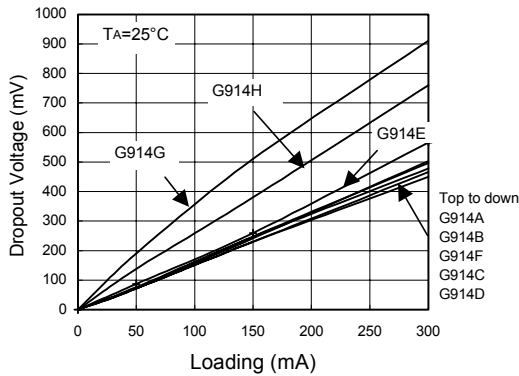
Output Voltage vs. Input Voltage



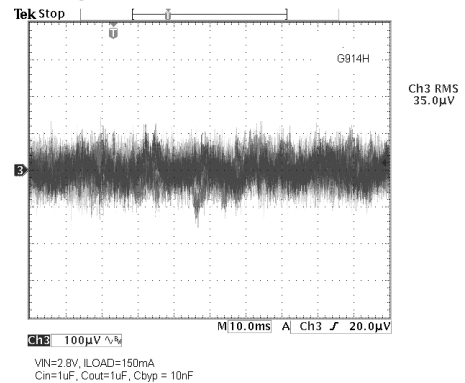
Supply Current vs. Input Voltage



Dropout Voltage vs. Load Current



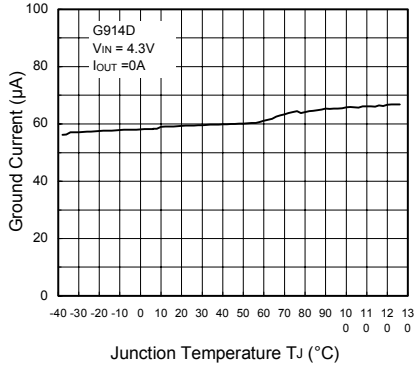
Output Noise 10KHZ to 100KHZ



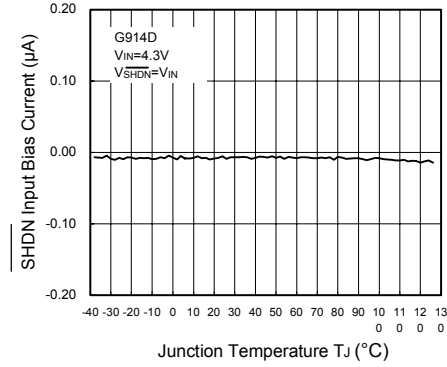


Typical Performance Characteristics (continued)

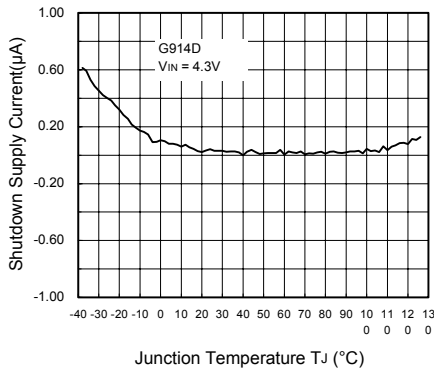
Ground Current vs. Temperature



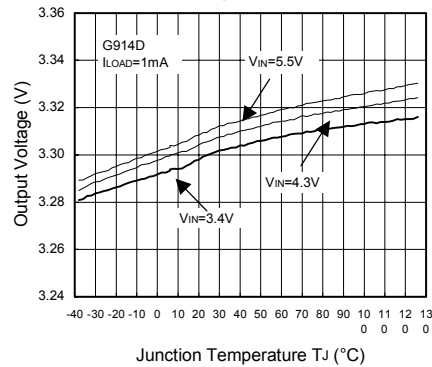
SHDN Input Bias Current vs. Temperature



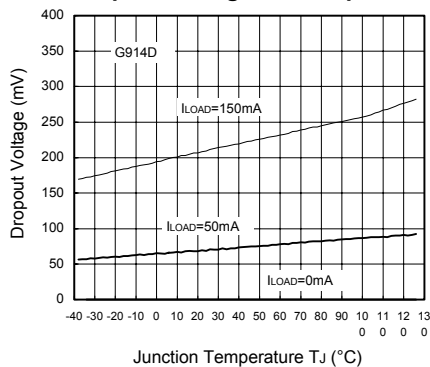
Shutdown Supply Current vs. Temperature



Output Voltage vs. Temperature



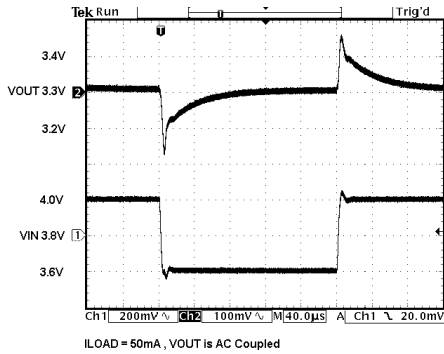
Dropout Voltage vs. Temperature



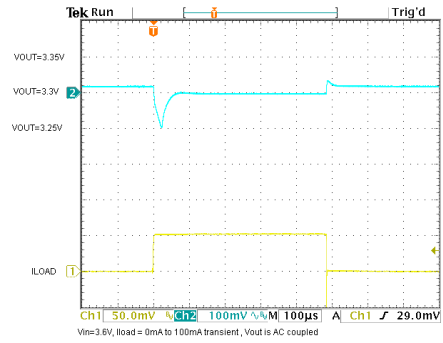


Typical Performance Characteristics (continued)

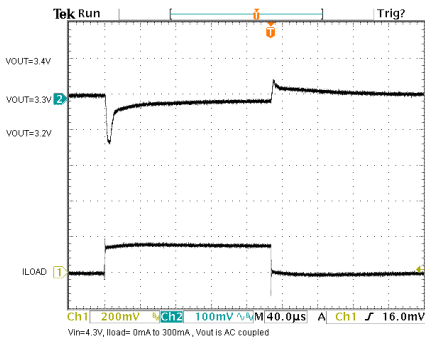
Line Transient



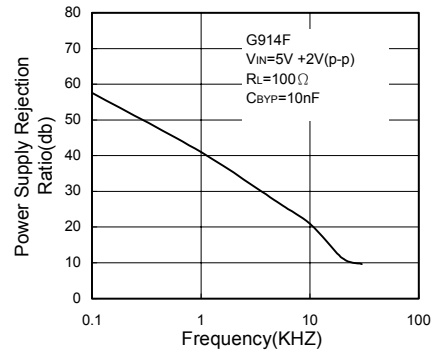
Load Transient



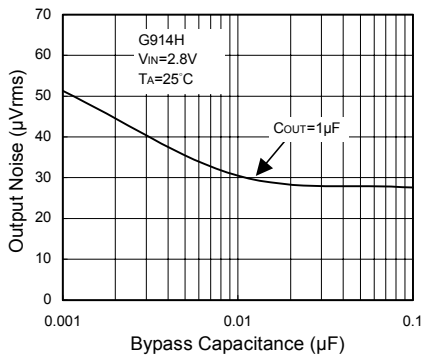
Load Transient



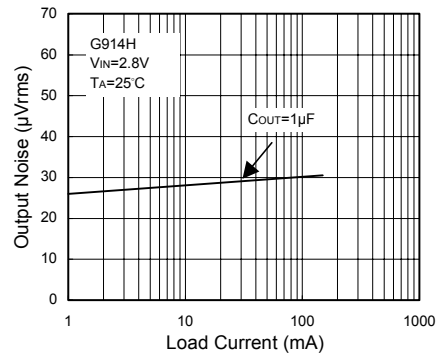
Power Supply Rejection Ripple



Output Noise vs. Bypass Capacitance



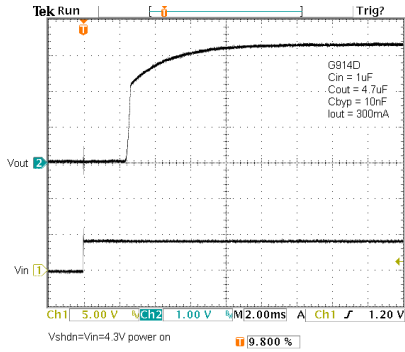
Output Noise vs. Load Current



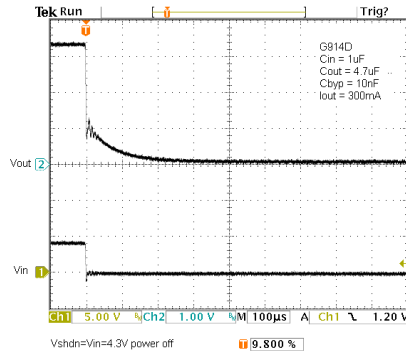


Typical Performance Characteristics (continued)

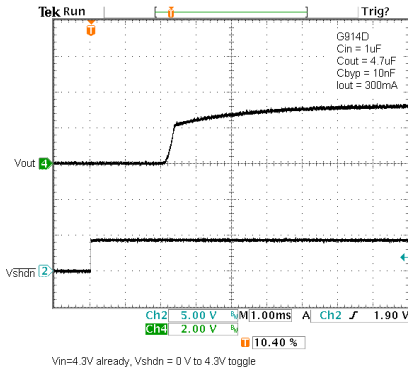
Power On Response Waveform



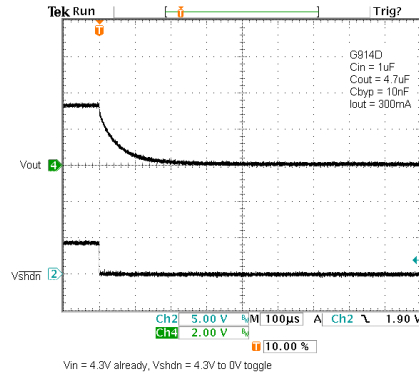
Power Off Response Waveform



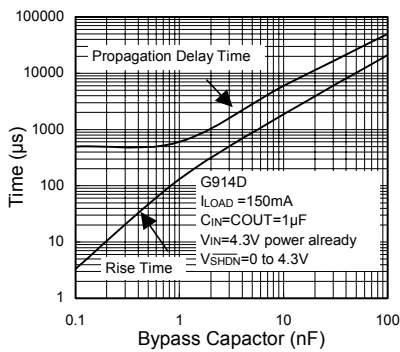
Shutdown Delay Waveform



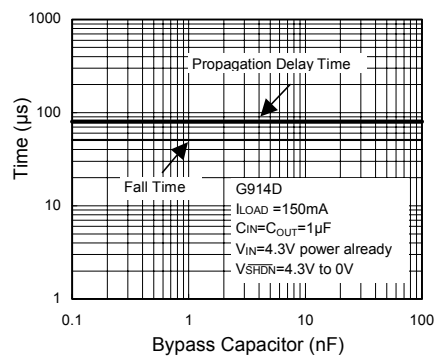
Shutdown Delay Waveform



Turn-On Time vs. Bypass Capacitance



Turn-Off Time vs. Bypass Capacitance



Pin Description

PIN	NAME	FUNCTION
1	IN	Regulator Input. Supply voltage can range from +2.5V to +5.5V. Bypass with 1 μ F to GND.
2	GND	Ground. This pin also functions as a heatsink. Solder to large pads or the circuit board ground plane to maximize thermal dissipation.
3	$\overline{\text{SHDN}}$	Active-High Enable Input. A logic low reduces the supply current to less than 1 μ A. Connect to IN for normal operation.
4	BYP	This is a reference bypass pin. It should connect external 10nF capacitor to GND to reduce output noise. Bypass capacitor must be no less than 1nF. ($C_{\text{BYP}} \geq 1\text{nF}$)
5	OUT	Regulator Output. Sources up to 150mA. Bypass with a 1 μ F, <0.2 Ω typical ESR capacitor to GND.

Detailed Description

The block diagram of the G914X is shown in Figure 1. It consists of an error amplifier, 1.25V bandgap reference, PMOS output transistor, internal feedback voltage divider, shutdown logic, over current protection circuit, and over temperature protection circuit.

The internal feedback voltage divider's central tap is connected to the non-inverting input of the error amplifier. The error amplifier compares non-inverting input with the 1.25V bandgap reference. If the feedback voltage is higher than 1.25V, the error amplifier's output becomes higher so that the PMOS output transistor has a smaller gate-to-source voltage (V_{GS}). This reduces the current carrying capability of the PMOS output transistor, as a result the output voltage decreases until the feedback voltage is equal to 1.25V.

Similarly, when the feedback voltage is less than 1.25V, the error amplifier causes the output PMOS to conduct more current to pull the feedback voltage up to 1.25V. Thus, through this feedback action, the error amplifier, output PMOS, and the voltage divider effectively form a unity-gain amplifier with the feedback voltage force to be the same as the 1.25V bandgap reference. The output voltage, V_{OUT} , is then given by the following equation:

$$V_{\text{OUT}} = 1.25 (1 + R1/R2). \quad (1)$$

Alternatively, the relationship between R1 and R2 is given by:

$$R1 = R2 (V_{\text{OUT}} / 1.25 + 1). \quad (2)$$

For the output voltage versions of G914X, the output voltages are 2.7V for G914A, 2.8V for G914B, 3.0V for G914C, 3.3V for G914D, and 2.5V for G914E, 2.85V for G914F, 1.50V for G914G and 1.80V for G914H.

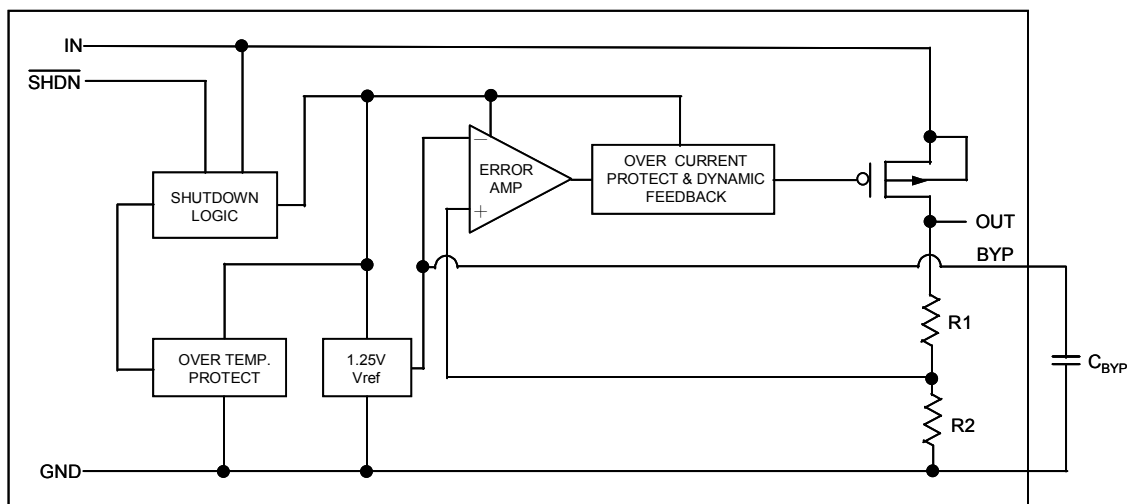


Figure 1. Functional Diagram

**Over Current Protection**

The G914X use a current mirror to monitor the output current. A small portion of the PMOS output transistor's current is mirrored onto a resistor such that the voltage across this resistor is proportional to the output current. This voltage is compared against the 1.25V reference. Once the output current exceeds the limit, the PMOS output transistor is turned off. Once the output transistor is turned off, the current monitoring voltage decreases to zero, and the output PMOS is turned on again. If the over current condition persist, the over current protection circuit will be triggered again. Thus, when the output is shorted to ground, the output current will be alternating between 0 and the over current limit. The typical over current limit of the G914X is set to 500mA. Note that the input bypass capacitor of 1 μ F must be used in this case to filter out the input voltage spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's routing wire. Otherwise, the actual voltage at the IN pin may exceed the absolute maximum rating.

Over Temperature Protection

To prevent abnormal temperature from occurring, the G914X has a built-in temperature monitoring circuit. When it detects the temperature is above 150°C, the output transistor is turned off. When the IC is cooled down to below 135°C, the output is turned on again. In this way, the G914X will be protected against abnormal junction temperature during operation.

Shutdown Mode

When the $\overline{\text{SHDN}}$ pin is connected a logic low voltage, the G914X enters shutdown mode. All the analog circuits are turned off completely, which reduces the current consumption to only the leakage current. The output is disconnected from the input. When the output has no load at all, the output voltage will be discharged to ground through the internal resistor voltage divider.

Operating Region and Power Dissipation

Since the G914X is a linear regulator, its power dissipation is always given by $P = I_{\text{OUT}} (V_{\text{IN}} - V_{\text{OUT}})$. The maximum power dissipation is given by:

$$P_{\text{DMAX}} = (T_{\text{J}} - T_{\text{A}}) / \theta_{\text{JA}} = (150-25) / 240 = 520\text{mW}$$

Where $(T_{\text{J}} - T_{\text{A}})$ is the temperature difference the G914X die and the ambient air, θ_{JA} , is the thermal resistance of the chosen package to the ambient air. For surface mount device, heat sinking is accomplished by using the heat spreading capabilities of the PC board and its copper traces. In the case of a SOT23-5 package, the thermal resistance is typically 240°C/Watt. (See Recommended Minimum Footprint) [Figure 2]. Refer to Figure 3 is the G914X valid operating region (Safe Operating Area) & refer to Figure 4 is maximum power dissipation of SOT 23-5.

The die attachment area of the G914X's lead frame is connected to pin 2, which is the GND pin. Therefore, the GND pin of G914X can carry away the heat of the G914X die very effectively. To improve the power dissipation, connect the GND pin to ground using a large ground plane near the GND pin.

Applications Information**Capacitor Selection and Regulator Stability**

Normally, use a 1 μ F capacitor on the input and a 1 μ F capacitor on the output of the G914X. Larger input capacitor values and lower ESR provide better supply-noise rejection and transient response. A higher-value input capacitor (10 μ F) may be necessary if large, fast transients are anticipated and the device is located several inches from the power source. For stable operation over the full temperature range, with load currents up to 120mA, a minimum of 1 μ F is recommended.

Power-Supply Rejection and Operation from Sources Other than Batteries

The G914X is designed to deliver low dropout voltages and low quiescent currents in battery powered systems. Power-supply rejection is 57dB at low frequencies as the frequency increases above 20kHz; the output capacitor is the major contributor to the rejection of power-supply noise.

When operating from sources other than batteries, improve supply-noise rejection and transient response by increasing the values of the input and output capacitors, and using passive filtering techniques.

Load Transient Considerations

The G914X load-transient response graphs show two components of the output response: a DC shift of the output voltage due to the different load currents, and the transient response. Typical overshoot for step changes in the load current from 0mA to 100mA is 12mV. Increasing the output capacitor's value and decreasing its ESR attenuates transient spikes.

Input-Output (Dropout) Voltage

A regulator's minimum input-output voltage differential (or dropout voltage) determines the lowest usable supply voltage. In battery-powered systems, this will determine the useful end-of-life battery voltage. Because the G914X use a P-channel MOSFET pass transistor, their dropout voltage is a function of $R_{\text{DS(ON)}}$ multiplied by the load current cause the G914X use a P-channel MOSFET pass transistor, their dropout voltage is a function of $R_{\text{DS(ON)}}$ multiplied by the load current.

Layout Guide

An input capacitance of $\cong 1\mu\text{F}$ is required between the G914X input pin and ground (the amount of the capacitance may be increased without limit), This capacitor must be located a distance of not more than 1cm from the input and return to a clean analog ground.

Input capacitor can filter out the input voltage spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's

routing wire. Otherwise, the actual voltage at the IN pin may exceed the absolute maximum rating.

The output capacitor also must be located a distance of not more than 1cm from output to a clean analog ground. Because it can filter out the output spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's routing wire. Figure 5 is G914X PCB recommended layout.

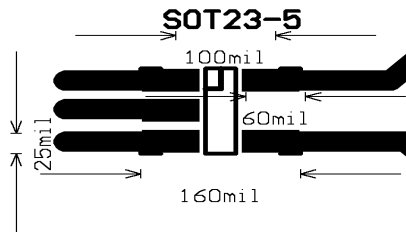


Figure 2. Recommended Minimum Footprint

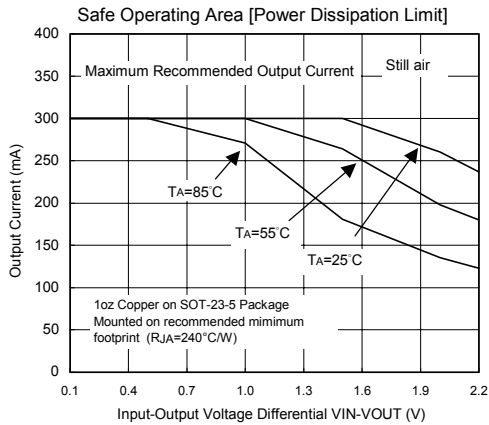


Figure 3. Safe Operating Area

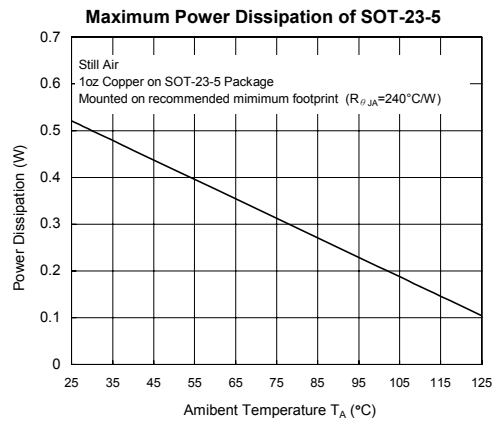


Figure 4. Power Dissipation vs. Temperature

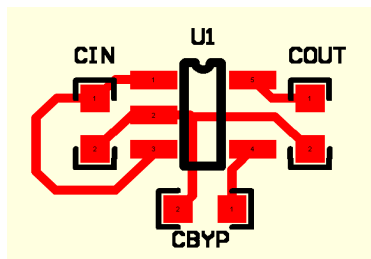
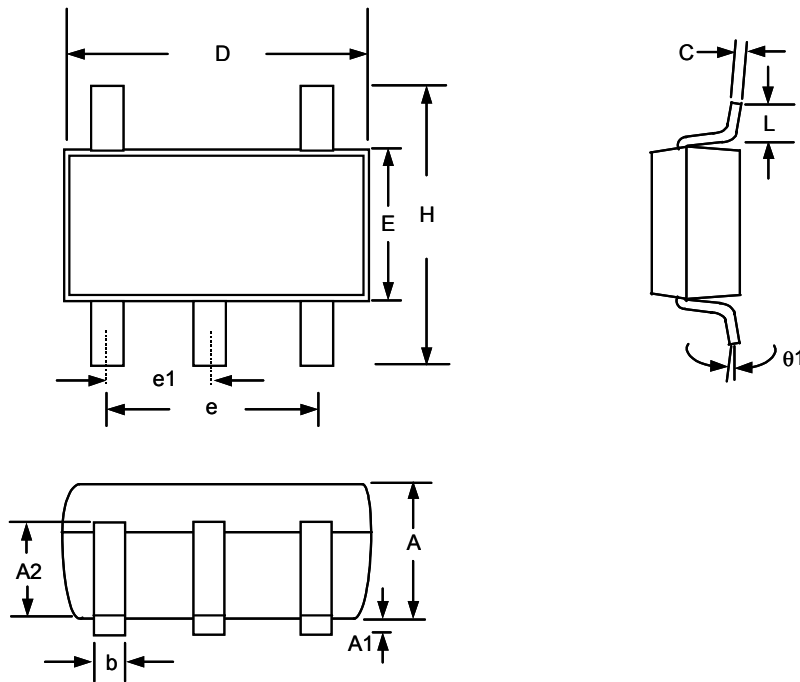


Figure 5. Fixed Mode

*Distance between pin & capacitor must no more than 1cm



Package Information



Note:

1. Package body sizes exclude mold flash protrusions or gate burrs
2. Tolerance ± 0.1000 mm (4mil) unless otherwise specified
3. Coplanarity: 0.1000mm
4. Dimension L is measured in gage plane

SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	1.00	1.10	1.30
A1	0.00	-----	0.10
A2	0.70	0.80	0.90
b	0.35	0.40	0.50
C	0.10	0.15	0.25
D	2.70	2.90	3.10
E	1.40	1.60	1.80
e	-----	1.90(TYP)	-----
e1	-----	0.95	-----
H	2.60	2.80	3.00
L	0.37	-----	-----
$\theta 1$	1°	5°	9°

Taping Specification

